

Surface Mount Power Splitter/Combiner

QBA-12+

2 Way-90° 50Ω 800 to 1200 MHz



Generic photo used for illustration purposes only

CASE STYLE: SM33

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Maximum Ratings

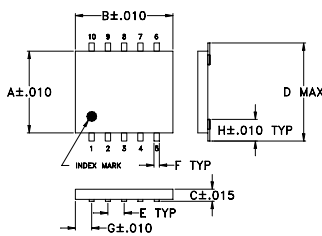
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.

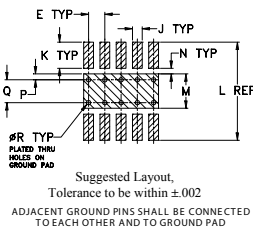
Pin Connections

SUM PORT	1
PORT 1 (+90°)	10
PORT 2 (0°)	6
GROUND	2,3,4,7,8,9
50 OHM TERM EXTERNAL	5

Outline Drawing



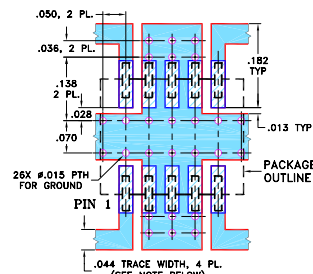
PCB Land Pattern



Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	
.250	.300	.050	.310	.050	.015	.050	.066	
6.35	7.62	1.27	7.87	1.27	0.38	1.27	1.68	
J	K	L	M	N	P	Q	R	wt
.030	.095	.330	.100	.020	.015	.070	.014	grams
0.76	2.41	8.38	2.54	0.51	0.38	1.78	0.36	0.2

Demo Board MCL P/N: TB-115+ Suggested PCB Layout (PL-004)



- NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4550B WITH DIELECTRIC THICKNESS .020 ± .0015; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
 ■ DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 ■ DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuit's standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp

Features

- low insertion loss, 0.25 dB typ.
- high power capability, 50W
- isolation, 23 dB typ.
- ceramic body, good for heat dissipation
- solder plated leads for excellent solderability
- aqueous washable
- protected by U.S. Patent 5,534,830

Applications

- cellular
- ISM

Electrical Specifications

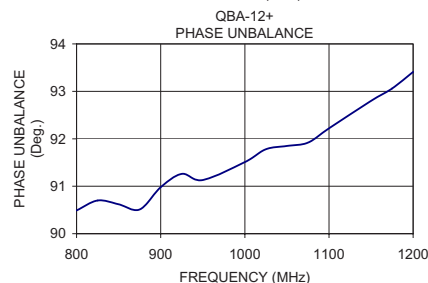
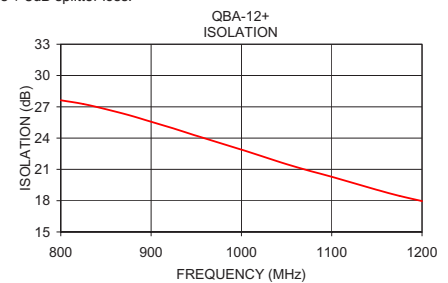
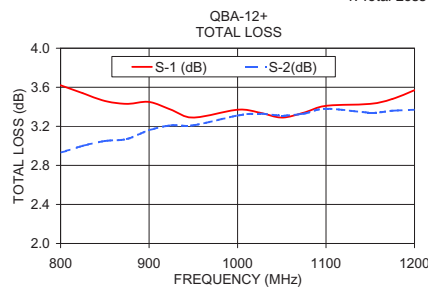
FREQ. RANGE (MHz)	ISOLATION (dB)		INSERTION LOSS ¹ (dB) Avg. of Coupled Outputs ABOVE 3 dB			PHASE UNBALANCE (Degrees)	AMPLITUDE UNBALANCE (dB)	INPUT POWER ² (W)
	Typ.	Min.	f_L	f_U	σ			
f_L - f_U			\bar{X}	\bar{X}	σ	Max.	Max.	below 25°C
800-1200	23	14	0.25	0.44	0.02	6.0	1.2	50

1. Includes test fixture losses.
 2. Derate linearly to 10W at 100°C
 Thermal compound may be applied to decrease body temperature. See application note AN-10-007

Typical Performance Data

Frequency (MHz)	Total Loss ¹ (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR S	VSWR 1	VSWR 2
	S-1	S-2						
800.00	3.62	2.93	0.70	27.63	90.49	1.08	1.21	1.09
825.00	3.54	3.00	0.54	27.27	90.70	1.08	1.21	1.09
850.00	3.46	3.05	0.40	26.77	90.62	1.08	1.22	1.09
875.00	3.43	3.07	0.36	26.21	90.51	1.08	1.23	1.09
900.00	3.45	3.16	0.28	25.57	90.98	1.09	1.24	1.10
925.00	3.37	3.21	0.16	24.92	91.26	1.09	1.25	1.10
950.00	3.29	3.21	0.09	24.23	91.13	1.11	1.26	1.11
1000.00	3.37	3.31	0.06	22.89	91.51	1.13	1.28	1.13
1025.00	3.34	3.33	0.01	22.20	91.78	1.15	1.29	1.15
1050.00	3.29	3.31	0.03	21.50	91.85	1.17	1.30	1.16
1075.00	3.34	3.33	0.01	20.87	91.92	1.19	1.31	1.17
1100.00	3.41	3.38	0.03	20.29	92.22	1.21	1.32	1.19
1150.00	3.43	3.34	0.09	19.04	92.80	1.26	1.35	1.23
1175.00	3.48	3.36	0.12	18.46	93.06	1.28	1.36	1.25
1200.00	3.57	3.37	0.20	17.96	93.41	1.31	1.37	1.27

1. Total Loss = Insertion Loss + 3dB splitter loss.



electrical schematic

